AUTOMOTIV

COMPLIANT

HALOGEN FREE

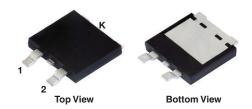


## Vishay General Semiconductor

# Dual TMBS® (Trench MOS Barrier Schottky) Rectifier

Ultra Low  $V_F = 0.29 \text{ V}$  at  $I_F = 5 \text{ A}$ 

### eSMP<sup>®</sup> Series SMPD (TO-263AC)





### **ADDITIONAL RESOURCES**



PRIMARY CHARACTERISTICS				
I <sub>F(AV)</sub>	2 x 15 A			
$V_{RRM}$	50 V			
I <sub>FSM</sub>	300 A			
$V_F$ at $I_F = 15 A$	0.42 V			
T <sub>J</sub> max.	150 °C			
Package	SMPD (TO-263AC)			
Circuit configuration	Common cathode			

#### **FEATURES**

- Trench MOS Schottky technology
- Very low profile typical height of 1.7 mm
- Ideal for automated placement
- · Low forward voltage drop, low power losses
- High efficiency operation
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
  - Automotive ordering code; base P/NHM3
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912">www.vishay.com/doc?99912</a>

#### **TYPICAL APPLICATIONS**

For use in high frequency DC/DC converters, switching power supplies, freewheeling diodes, OR-ing diode, and reverse battery protection.

#### **MECHANICAL DATA**

Case: SMPD (TO-263AC)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant, and

commercial grade

Base  $P/NHM3_X$  - halogen-free, RoHS-compliant, and

AEC-Q101 qualified

("\_X" denotes revision code e.g. A, B,....)

Terminals: matte tin plated leads, solderable per

J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 2 whisker test, HM3 suffix meets JESD 201 class 2 whisker test

Polarity: as marked

MAXIMUM RATINGS (T <sub>A</sub> = 25 °C unless otherwise noted)					
PARAMETER		SYMBOL	V30DL50C	UNIT	
Maximum repetitive peak reverse voltage		V <sub>RRM</sub>	50	V	
Maximum average forward rectified current (fig. 1)	per device	I <sub>F(AV)</sub>	30	А	
	per diode		15		
Peak forward surge current 10 ms single half sine-wave superimposed on rated load		I <sub>FSM</sub>	300	А	
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>STG</sub>	-40 to +150	°C	



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<b>ELECTRICAL CHARACTERISTICS</b> (T <sub>A</sub> = 25 °C unless otherwise noted)							
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT	
Instantaneous forward voltage per diode	I <sub>F</sub> = 5 A	T <sub>A</sub> = 25 °C	V <sub>F</sub> <sup>(1)</sup>	0.39	-	V	
	I <sub>F</sub> = 7.5 A			0.42	-		
	I <sub>F</sub> = 15 A			0.49	0.57		
	I <sub>F</sub> = 5 A	T <sub>A</sub> = 125 °C		0.29	-		
	I <sub>F</sub> = 7.5 A			0.33	-		
	I <sub>F</sub> = 15 A			0.42	0.50		
Reverse current per diode	V <sub>B</sub> = 50 V	$T_A = 25  ^{\circ}\text{C}$ $T_A = 125  ^{\circ}\text{C}$	I <sub>R</sub> <sup>(2)</sup>	-	1800	μA	
	v <sub>R</sub> = 50 v			25	60	mA	
Typical junction capacitance	4.0 V, 1 MHz	T <sub>A</sub> = 25 °C	CJ	2800	-	pF	

#### **Notes**

 $^{(1)}\,$  Pulse test: 300  $\mu s$  pulse width, 1 % duty cycle

(2) Pulse test: pulse width ≤ 40 ms

THERMAL CHARACTERISTICS (T <sub>A</sub> = 25 °C unless otherwise noted)					
PARAMETER		SYMBOL	V30DL50C	UNIT	
	per diode	- R <sub>0</sub> JC - R <sub>0</sub> JA (1)(2)	1.7		
Typical thermal resistance	per device		0.9	°C/W	
	per device		45		

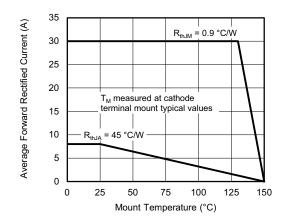
#### Notes

<sup>(2)</sup> Free air, without heatsink

ORDERING INFORMATION (Example)							
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE			
V30DL50C-M3/I	0.55	I	2000/reel	13" diameter plastic tape and reel			
V30DL50CHM3_A/I (1)	0.55	I	2000/reel	13" diameter plastic tape and reel			

#### Note

### RATINGS AND CHARACTERISTICS CURVES (T<sub>A</sub> = 25 °C unless otherwise noted)





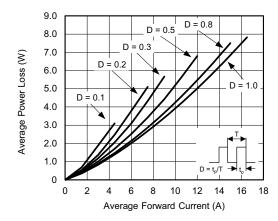


Fig. 2 - Forward Power Loss Characteristics Per Diode

<sup>(1)</sup> The heat generated must be less than the thermal conductivity from junction-to-ambient:  $dP_D/dT_J < 1/R_{\theta,JA}$ 

<sup>(1)</sup> AEC-Q101 qualified



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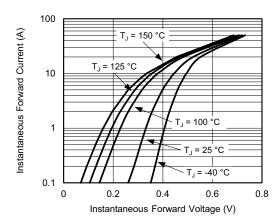


Fig. 3 - Typical Instantaneous Forward Characteristics Per Diode

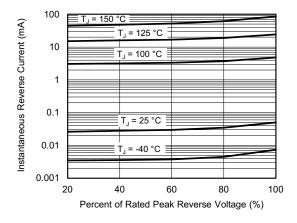


Fig. 4 - Typical Reverse Characteristics Per Diode

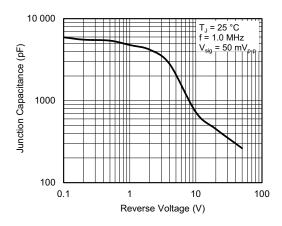


Fig. 5 - Typical Junction Capacitance Per Diode

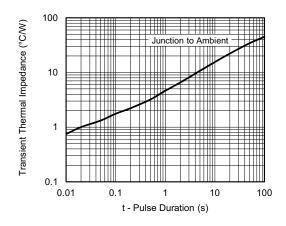


Fig. 6 - Typical Transient Thermal Impedance Per Device

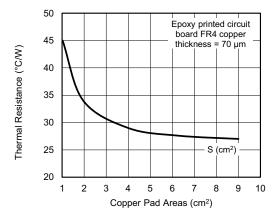
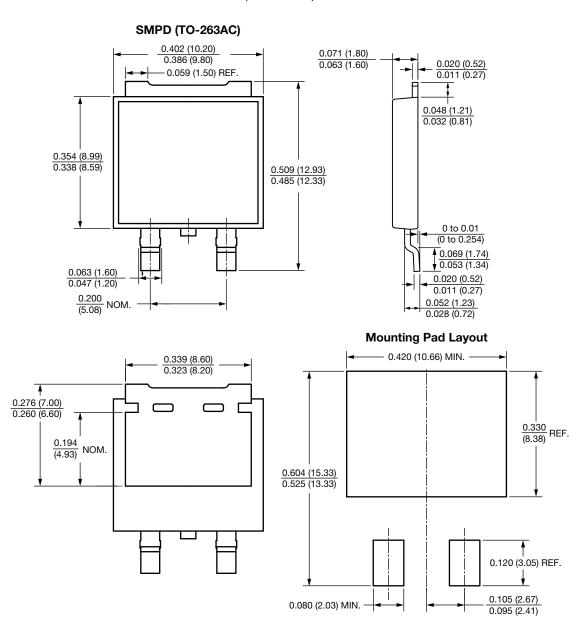


Fig. 7 - Thermal Resistance Junction-to-Ambient vs. Copper Pad Areas



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### **PACKAGE OUTLINE DIMENSIONS** in inches (millimeters)





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